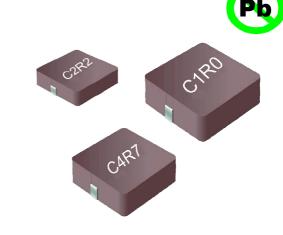


SMD Molding Power Inductor

Features

- 1. Magnetically shielded construction, low DC resistance;
- The use of magnetic iron powder ensure capability for large current;
- 3. Low audible core noise:
- 4. Ideal for DC-DC converter applications in hand held personal computer and etc;
- 5、Frequency Range: up to 3.0MHz;
- 6、RoHS compliant。



Applications

- 1、Smart phone、MID;
- 2. Next-generation mobile devices with multifunction such as adding color TV and digital movie cameras;
- 3、Flat-screen TVs, blue-ray disc recorders, set top box;
- 4. Notebooks, desktop computers, servers, graphic cards;
- 5. Portable gaming devices, personal navigation systems, personal multimedia devices;
- 6. Automotive systems;
- 7、Telecomm base stations。

◆ Lead Free Part Numbering

CMLO 1360 H 100 M T T (1) (2) (3) (4) (5) (6) (7)

(1) Series Type

(2) Dimension: AXC

(3) Material Code

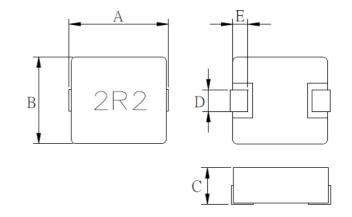
(4) Inductance: 2R2=2.2μH;

100=10μH; 101=100μH

(5) Inductance Tolerance: M=±20%, Y=±30%

(6) Company Code

(7) Packaging: packed in embossed carrier tape



Dimensions

Series	A±0.3 (mm)	B ±0.3 (mm)	C (mm)	D±0.3 (mm)	E±0.3 (mm)
CMLO1360H	13.6 Max	12.6 Max	6.0 Max	3.5	2.5

Rev.01 Page 1 of 8 www.cybermaxtech.com



♦ Specification

Part Number	INDUCTAN CE Lo(μ H)	Rdc (m Ω) Max	Test a condition	SATURATION CURRENT(Isat) DC AMPS2 (Typ.)	HEAT RATING CURRENT(Idc) DC AMPS1 (Typ.)
CMLO1360H Series					
CMLO1360H4R7MTT	4.7	9	100KHz/1V	24	15
CMLO1360H5R6MTT	5.6	11	100KHz/1V	22.5	13
CMLO1360H6R8MTT	6.8	13.5	100KHz/1V	19	12
CMLO1360H8R2MTT	8.2	16	100KHz/1V	13.5	11
CMLO1360H100MTT	10	20.7	100KHz/1V	12.5	10
CMLO1360H120MTT	12	23	100KHz/1V	10	9.0
CMLO1360H150MTT	15	29	100KHz/1V	9	8.5
CMLO1360H180MTT	18	35	100KHz/1V	8.0	7.5
CMLO1360H220MTT	22	39.5	100KHz/1V	7.5	7.0
CMLO1360H270MTT	27	56	100KHz/1V	6.5	6.0
CMLO1360H330MTT	33	75	100KHz/1V	6.0	5.5
CMLO1360H470MTT	47	90	100KHz/1V	5.5	5.0
CMLO1360H680MTT	68	140	100KHz/1V	4.5	4.0
CMLO1360H101MTT	100	200	100KHz/1V	3.5	3.0
CMLO1360H121MTT	120	235	100KHz/1V	3.2	2.0
CMLO1360H151MTT	150	350	100KHz/1V	2.7	1.5

NOTES:

- 1. DC current (Idc) that will cause an approximate △T of 40°C
- 2. DC current (Isat) that will cause Lo to drop approximately 20%
- 4. Operating Temperature Range -55°C to +150°C
- 5. The part temperature (ambient + temp rise) should not exceed $150\,^{\circ}$ C under the worst operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

Rev.01 Page 2 of 8 www.cybermaxtech.com



◆ Reliability Test

Item	Specification and Requirement	Test Method				
	1. No case deformation or change in	1.Preheat: 155℃±5℃ , 60S±2S				
Solderability	apperarance	2.Tin: lead-free.				
	2. New solder coverage More than 90%	3.Temperature:245℃±5℃, flux 3.0S±0.5S.				
	1. No case deformation or change in	1. Acceleration: 100G				
Mechanical	apperarance	2. Pulse time:: 6ms				
shock	2. △L/Lo≦±10%	3. 3 times in each positive and negative direction of 3				
		mutual perpendicular directions				
	1. No case deformation or change in	1. The test samples shall be soldered to the board.				
	apperarance	Then it shall be submitted to below test conditions.				
	2. △L/Lo≦±10%	Fre. Range 10~55Hz				
Mechanical		Total Amplitude 1.5mm				
vibration		Sweeping Method 10Hz to 55Hz to 10Hz				
		Time For 2 hours on each X,Y,Z axis.				
		2. Recovery: At least 2 hours of recovery under the				
		standard condition after the test, followed by the				
		measurement within 24 ±2 hours.				
	Inductance change:	1. First -55°C for 30 minutes, last 125°C for 30				
	Within ± 10% Without distinct damage	minutes as 1 cycle. Go through 1000 cycles.				
Thermal Shock	in appearance	2. Max transfer time is 2 minutes.				
		3. Measured at room temperature after placing for				
		24±2 hours				
	Inductance change:	1.Reflow 2 times,				
Humidity	Within ± 10% Without distinct damage	2.85℃,85%RH,1000 hours				
Resistance	in appearance	3.Measured at room temperature after placing for				
		24±2 hours				
Low	Inductance change:	1. Temperature: -55 ± 2 ℃				
temperature	Within ± 10% Without distinct damage	2. Time: 1000 hours				
storage	in appearance	3. Measured at room temperature after placing for				
0.01.030		24±2 hours				
I I : b	Inductance change:	1. Temperature: +125 ± 2℃				
High	Within ± 10% Without distinct damage	2. Time: 1000 hours				
temperature storage	in appearance	3. Measured at room temperature after placing for				
Sicraye		24±2 hours				

Rev.01 Page 3 of 8 www.cybermaxtech.com



	Inductance change:	1、Run through IR reflow for 2 times;
	Within ± 10% Without distinct damage	2. Place the 100mm X 40mm board into a fixture
	in appearance	similar to the one shown in below Figure with the
		component facing down
		3. The apparatus shall consist of mechanical means
		to apply a force which will bend the board (D) x = 2
		mm minimum.
		4. The duration of the applied forces shall be 60±5
Board Flex		sec. The force is to be applied only once to the oard.
		Support Solder Chip Printed circuit board before to
		Printed circuit board under test Printed circuit board under test Displacement
	No removal or split of the termination or	1. The test samples shall be soldered to the board
	other defects shall occur.	2. Push the product vertically from the side of the
		sample using the thrust tester.
		3、Automotive electronics: 17.7N,60S±1s,X,
Terminal		Ydirect. X direct
Strength		Y direct

Rev.01 Page 4 of 8 www.cybermaxtech.com



♦ Recommended Soldering Technologies

(1) Re-flowing Profile

Preheat condition: 150 ~200 °C/60~180sec.

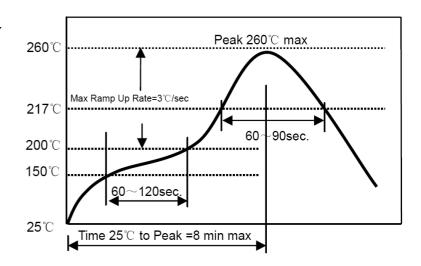
Allowed time above 217°C: 80~120sec.

Max temp: 260°C

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max



(2) Iron Soldering Profile

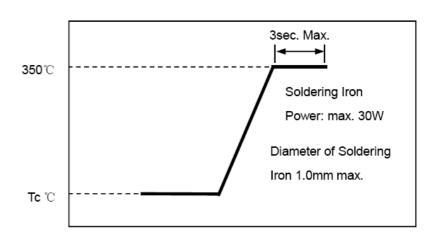
Iron soldering power: Max. 30W

Pre-heating: 150 °C/60sec.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

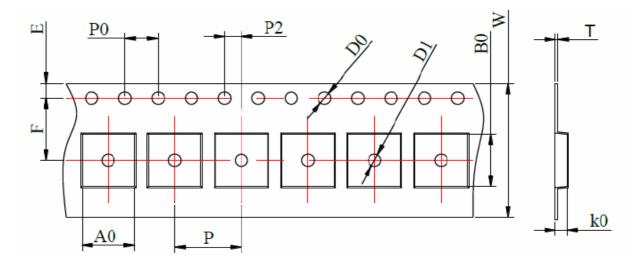
Max.1 times for iron soldering





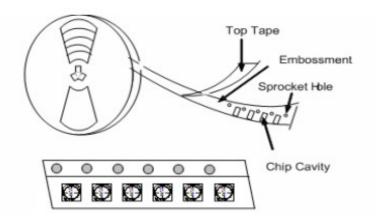
◆ Packaging Information

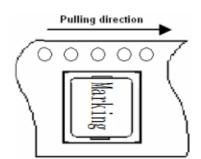
(1) Tape Packaging Dimensions (Unit: mm)



Туре		Tape dimensions (mm)										
	W	Р	P0	P2	D0	D1	Т	A0	В0	K0	Е	F
CMLO1360	24 ±0.3	16 ±0.1	4.0 ±0.1	2.0 ±0.1	1.5 ±0.1	1.5 ±0.1	0.5 ±0.05	13.1 ±0.1	14 ±0.1	5.4 ±0.1	1.75 ±0.1	11.5 ±0.1

Taping Drawings (UNIT:mm)

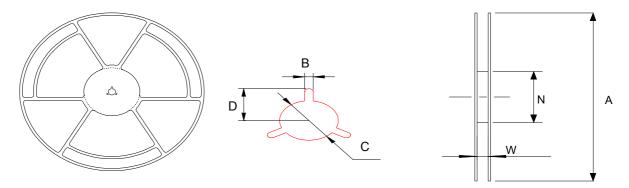




Rev.01 Page 6 of 8 www.cybermaxtech.com



(2) Reel Dimensions (Unit: mm)



А	W	N	В	С	D
330+2.0	24±0.5	97±0.5	2.2+0.5	13.0±0.2	10.75±0.25

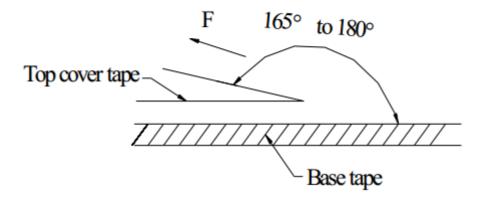
(3) Packaging Quantity(PCS)

Tymo	Standard Quantity				
Туре	Reel Inner box		Carton box		
CMLO1360	500 pcs / reel	2Reel / box (1000 pcs)	4 Middle boxes, (4000 pcs)		

(4) Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



Rev.01 Page 7 of 8 www.cybermaxtech.com



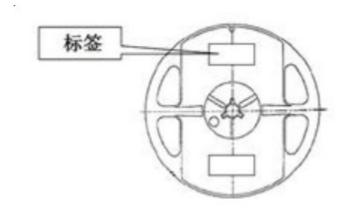
(5) Reel Label

Label on the reel

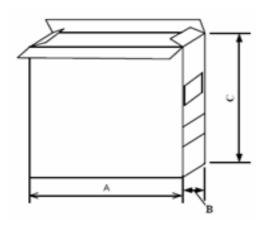
- · Customer's part Number
- Lot Number
- Quantity
- date code

Shipping Label

- Customer's part Number
- · Manufacturer's part Number
- Quantity
- · date code

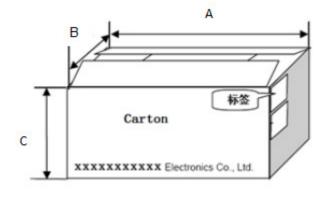


(6) Inner Box



Packaging type	A (mm)	B (mm)	C (mm)
lnner box	335	70	340

(7) Carton



Packaging type	A (mm)	B (mm)	C (mm)
type	360	360	360

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Fixed Inductors category:

Click to view products by Cybermax manufacturer:

Other Similar products are found below:

CR32NP-151KC CR32NP-180KC CR32NP-181KC CR32NP-1R5MC CR32NP-390KC CR32NP-3R9MC CR32NP-680KC CR32NP-680KC CR32NP-680KC CR32NP-680KC CR32NP-820KC CR32NP-8R2MC CR43NP-390KC CR43NP-560KC CR43NP-680KC CR54NP-181KC CR54NP-470LC CR54NP-820KC CR54NP-8R5MC 70F224AI MGDQ4-00004-P MHL1ECTTP18NJ MHQ1005P10NJ MHQ1005P1N0S MHQ1005P2N4S MHQ1005P3N6S MHQ1005P5N1S MHQ1005P8N2J PE-51506NL PE-53601NL PE-53602NL PE-53630NL PE-53824SNLT PE-92100NL PG0434.801NLT PG0936.113NLT 9220-20 9310-16 PM06-2N7 PM06-39NJ A01TK 1206CS-471XJ HC2LP-R47-R HC2-R47-R HC3-2R2-R HCF1305-3R3-R 1206CS-151XG RCH664NP-140L RCH664NP-4R7M RCH8011NP-221L RCP1317NP-332L RCP1317NP-391L RCR1010NP-470M